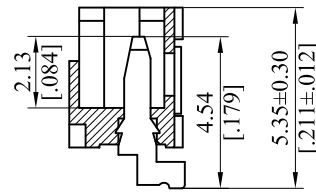
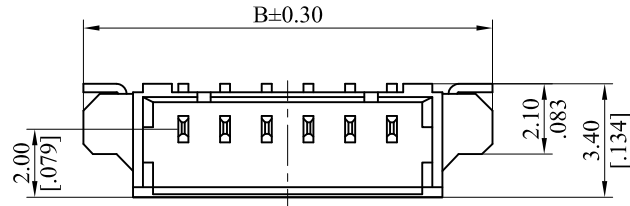


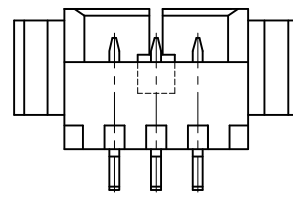
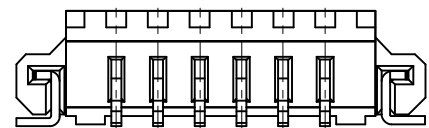
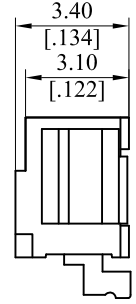
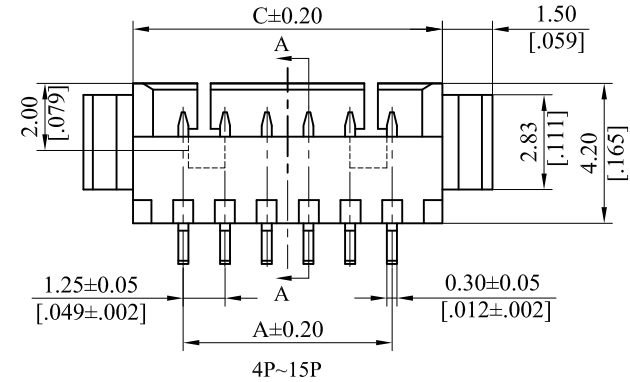
RoHS COMPLIANT

CUSTOMER DRAWING

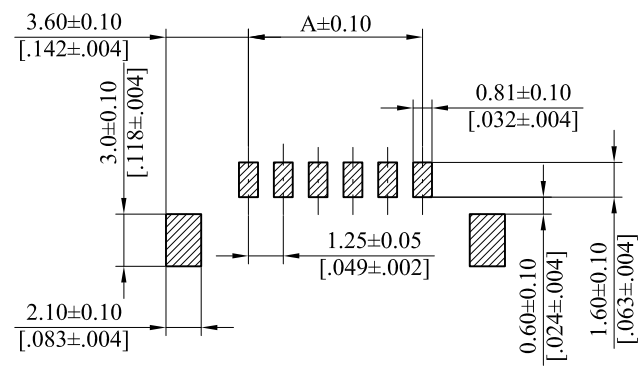
REV.	ECO. NO.	DESCRIPTION	DATE
H	ES170822	UPDATE	2017.08.18



Section A - A



2P~3P



Recommended PCB Layout

Note:

Material:

Insulator: High Temperature Thermoplastic, UL94V-0, Natural
 Contact: Copper Alloy
 Solder Tabs: Brass

Specifications:

Current Rating: 1A AC, DC
 Voltage Rating: 125V AC, DC
 Temperature Rating: -40°C ~ +105°C

General Part Number:

1254P ** M H * 0
 1 2

1.No. of circuits(02~15)

2.Plating

- 0= Matte Tin plated 80µ"min. over 30µ"min. Nickel underplating overall
- F= Selective Gold flash on contact area over 30µ"min. Nickel underplating overall, Tin plated on solder tails
- J= 15µ"min. Selective Gold on contact area over 30µ"min. Nickel underplating overall, Tin plated on solder tails
- K= 30µ"min. Selective Gold on contact area over 30µ"min. Nickel underplating overall, Tin plated on solder tails

A=1.25mm(.049")*No. of spaces
 B=A+6.00mm(.236")
 C=A+3.00mm(.118")

TOLERANCE UNLESS OTHERWISE SPECIFIED			LEOCO CORPORATION http://www.leoco.com.tw		
mm [inch]	mm	inch	APPROVED BY:	DATE:	TITLE:
1 PLACE	± 0.30	± --	Chard	2017.08.18	1.25mm(.049") Pitch Right Angle Type SMT Wafer
2 PLACES	± 0.20	± .012	Angel	2017.08.18	
3 PLACES	± 0.10	± .008	DRAWN BY:	DATE:	PART NO.:
4 PLACES	± --	± .004	Brian	2017.08.18	1254P**MH*0
ANGULAR ±1°			SIZE:	SCALE:	DRAWING NO.:
			A3	1:1	125407S
					REV.:
					H
					SHEET:
					1 OF 1